



## 20V/7A Dual N-Channel Enhancement Mode MOSFET

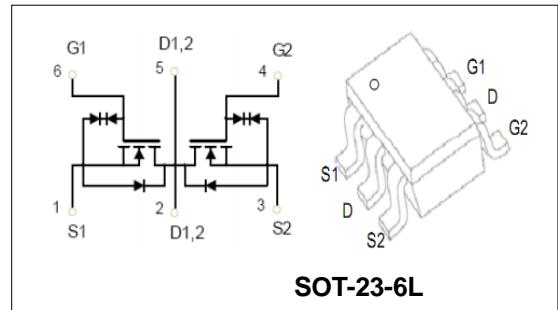
**Features**

- New technology for high voltage device.
- Low on-resistance and low conduction losses
- Small package
- Ultra Low Gate Charge cause lower driving requirements

BVDSS	20	V
ID	7	A
RDSON@VGS=4.5V	12	mΩ
RDSON@VGS=2.5V	15	mΩ
RDSON@VGS=1.8V	23	mΩ

**Applications**

- Ideal for Li ion battery pack applications



SOT-23-6L

**Order Information**

Product	Package	Marking	Reel Size	Reel	Carton
PT8810A	SOT-23-6L	PT8810A	7inch	3000PCS	180000PCS

**Absolute Maximum Ratings**

Symbol	Parameter	Rating	Unit	
<b>Common Ratings (TC=25°C Unless Otherwise Noted)</b>				
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	20	V	
$V_{GS}$	Gate-Source Voltage	$\pm 12$	V	
$T_J$	Maximum Junction Temperature	150	°C	
$T_{STG}$	Storage Temperature Range	-55 to 150	°C	
$I_S$	Diode Continuous Forward Current	TA =25°C	7	A

**Mounted on Large Heat Sink**

$I_{DM}$	Pulse Drain Current Tested (Silicon Limit) (Note1)	TA =25°C	30	A
$I_D$	Continuous Drain current	TA =25°C	7	A
$P_D$	Maximum Power Dissipation	TA =25°C	0.6	W
$R_{θJA}$	Thermal Resistance Junction-to-Ambient (Note2)		208.3	°C/W

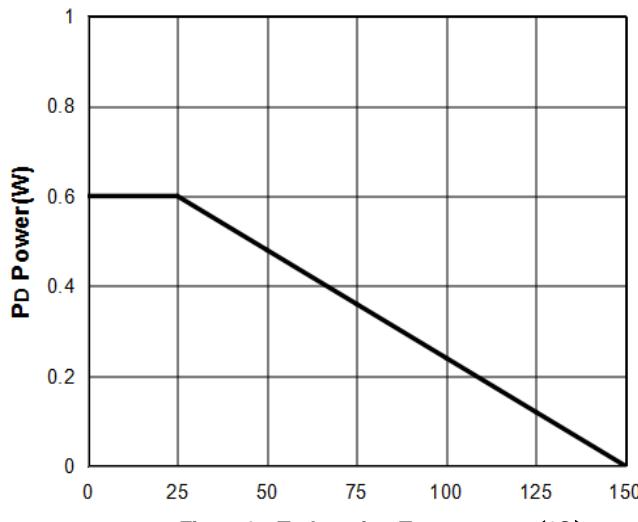
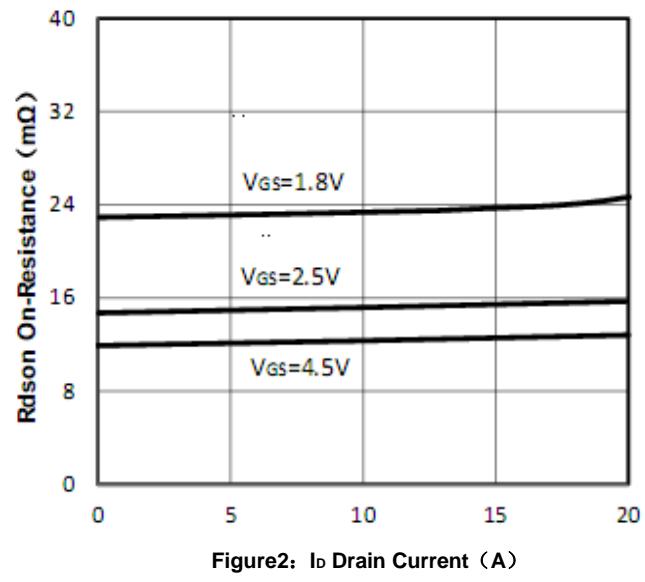
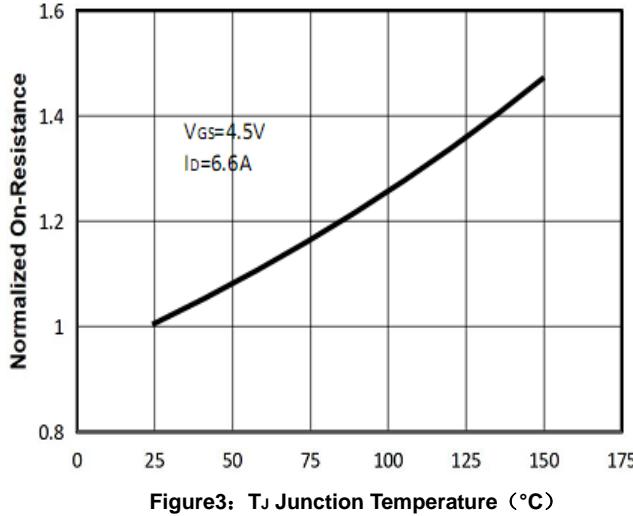
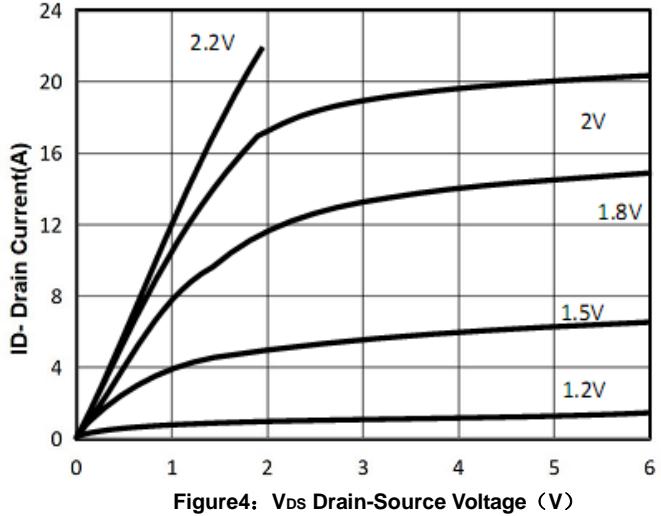
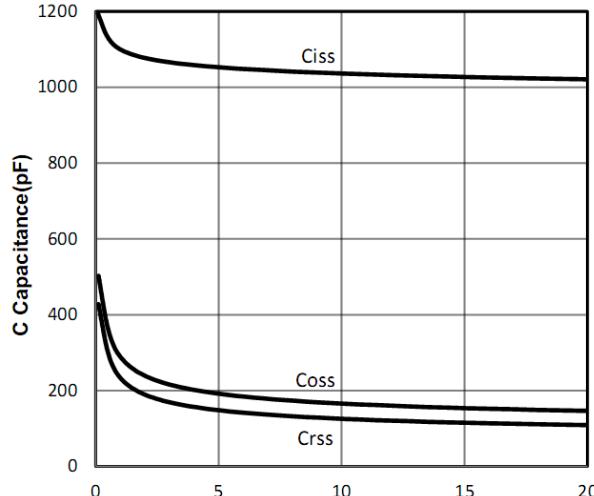
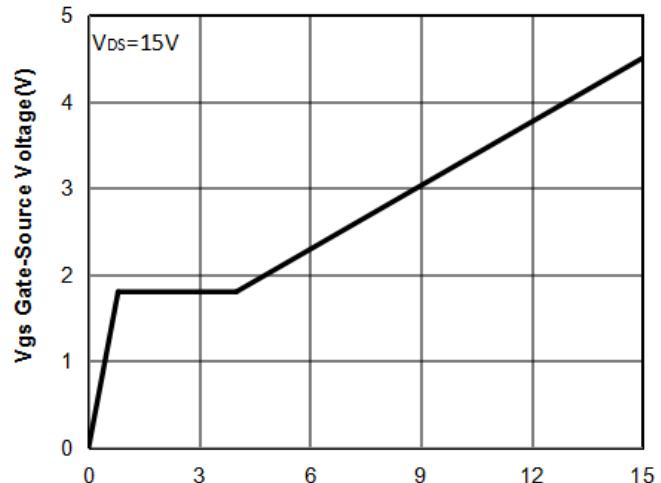


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Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
<b>Static Electrical Characteristics @ TJ = 25°C (unless otherwise stated)</b>						
$V_{(BR)DSS}$	Drain- Source Breakdown Voltage	$VGS=0V$ $ID=250\mu A$	20	--	--	V
$I_{DSS}$	Zero Gate Voltage Drain current	$VDS=16V$ , $VGS=0V$	--	--	1	$\mu A$
$I_{GSS}$	Gate-Body Leakage Current	$VGS=\pm 8V$ , $VDS=0V$	--	--	$\pm 10$	nA
$V_{GS(TH)}$	Gate Threshold Voltage	$VDS=VGS$ , $ID=250\mu A$	0.4	0.77	1.0	V
$R_{DS(ON)}$	Drain-Source On-State Resistance (Note3)	$VGS=4.5V$ , $ID=6.6A$	--	12	22	mΩ
		$VGS=2.5V$ , $ID=5.5A$	--	15	26	
		$VGS=1.8V$ , $ID=5A$	--	23	35	
<b>Dynamic Electrical Characteristics @ TJ = 25°C (unless otherwise stated) (Note4)</b>						
$C_{iss}$	Input Capacitance	$VDS=10V$ , $VGS=0V$ , $F=1MHz$	--	1150	--	pF
$C_{oss}$	Output Capacitance		--	185	--	pF
$C_{rss}$	Reverse Transfer Capacitance		--	145	--	pF
$Q_g$	Total Gate Charge	$VDS=10V$ , $ID=7A$ , $VGS=4.5V$	--	15	--	nC
$Q_{gs}$	Gate-Source Charge		--	0.8	--	nC
$Q_{gd}$	Gate-Drain Charge		--	3.2	--	nC
<b>Switching Characteristics (Note4)</b>						
$t_{d(on)}$	Turn-on Delay Time	$VDD=10V$ , $RL=1.35\Omega$ , $VGS=5V$ $RG=3\Omega$	--	6	--	nS
$t_r$	Turn-on Rise Time		--	13	--	nS
$t_{d(off)}$	Turn-off Delay Time		--	52	--	nS
$t_f$	Turn-off Fall Time		--	16	--	nS
<b>Source- Drain Diode Characteristics@ TJ = 25°C (unless otherwise stated)</b>						
$V_{SD}$	Forward on voltage	$IS=1A$ , $VGS=0V$	--	--	1	V
$t_{rr}$	Reverse Recovery Time	$I_F=20A$ $dI/dt=100A/us$	--	--	--	nS
$Q_{rr}$	Reverse Recovery Charge		--	--	--	nC

Note:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board,  $t \leq 10$  sec.
3. Pulse Test: pulse width  $\leq 300$  us, duty cycle  $\leq 2\%$ .
4. Guaranteed by design, not subject to production testing.

**20V/7A Dual N-Channel Enhancement Mode MOSFET**
**Typical Characteristics**

**Figure1:  $T_J$  Junction Temperature (°C)**

**Figure2:  $I_D$  Drain Current (A)**

**Figure3:  $T_J$  Junction Temperature (°C)**

**Figure4:  $V_{DS}$  Drain-Source Voltage (V)**

**Figure5:  $V_{DS}$  Drain-Source Voltage (V)**

**Figure6:  $Q_g$  Gate Charge (nC)**

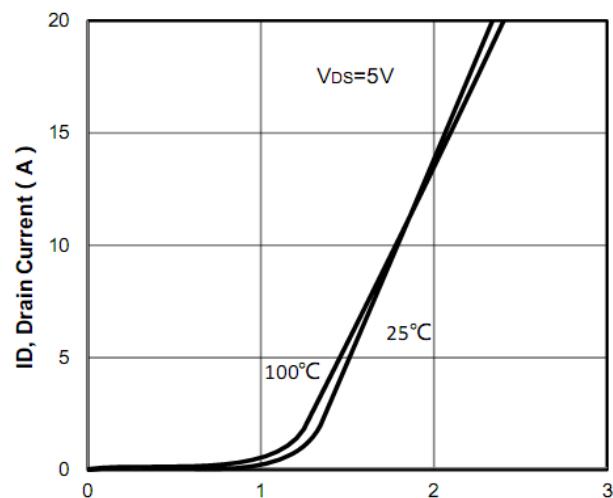
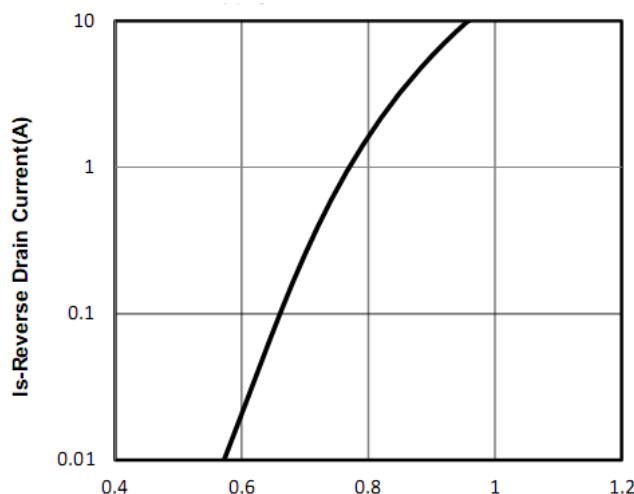
**20V/7A Dual N-Channel Enhancement Mode MOSFET**


Figure 7: V<sub>sd</sub> Source-Drain Voltage (V)

Figure 8: V<sub>gs</sub> Gate-Source Voltage (V)

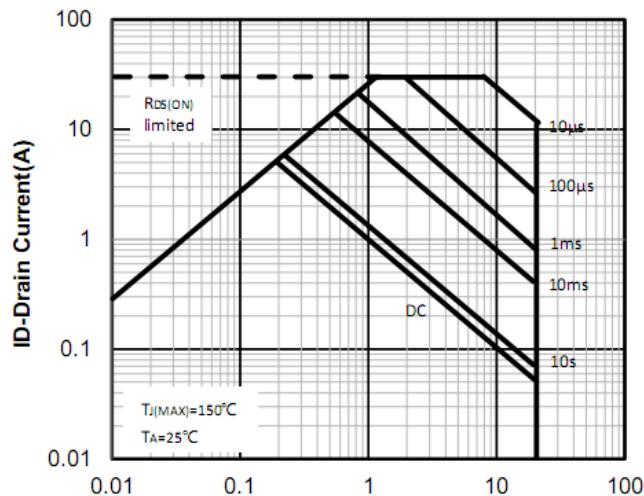


Figure 9: V<sub>DS</sub> Drain -Source Voltage (V) vs ID-Drain Current (A)

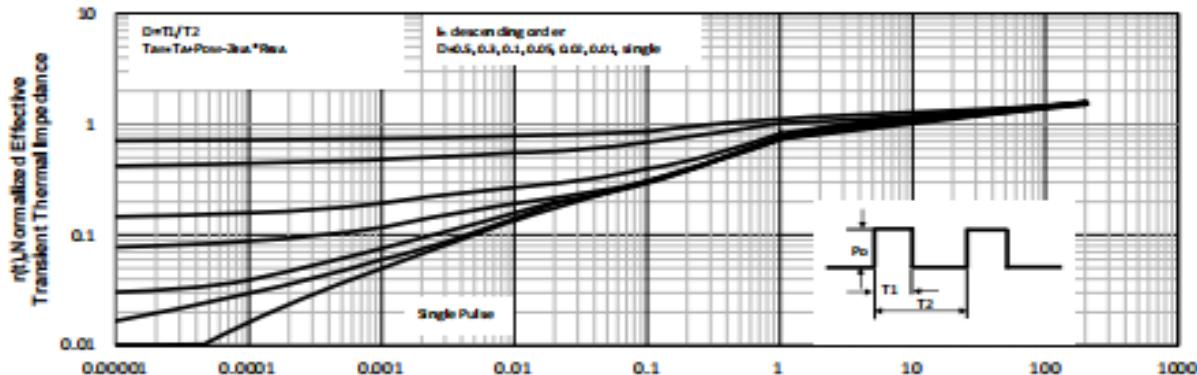
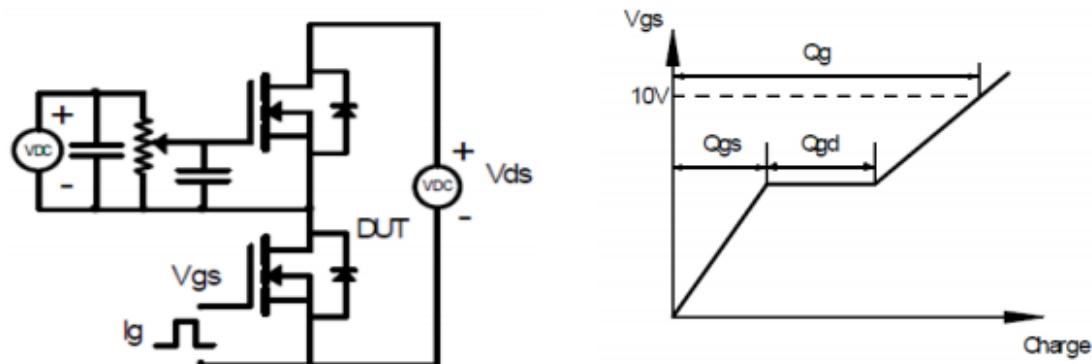
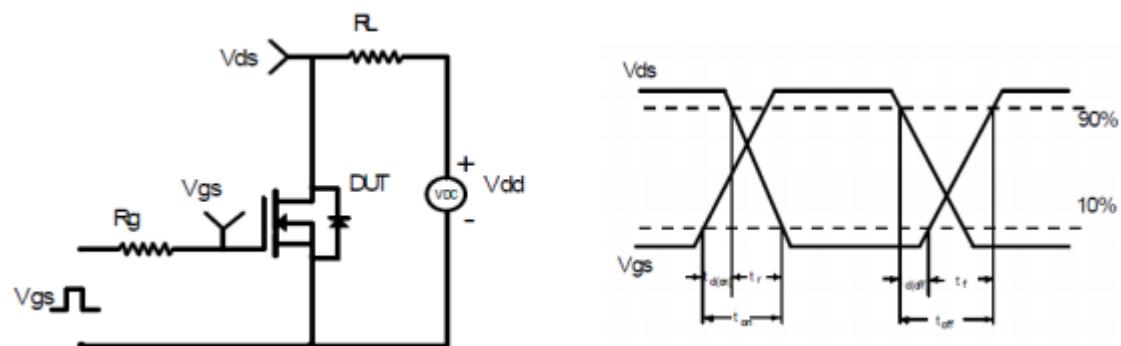
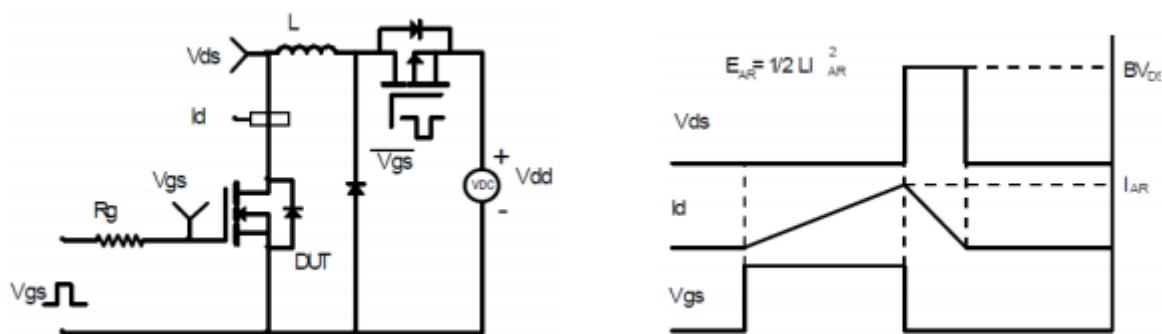
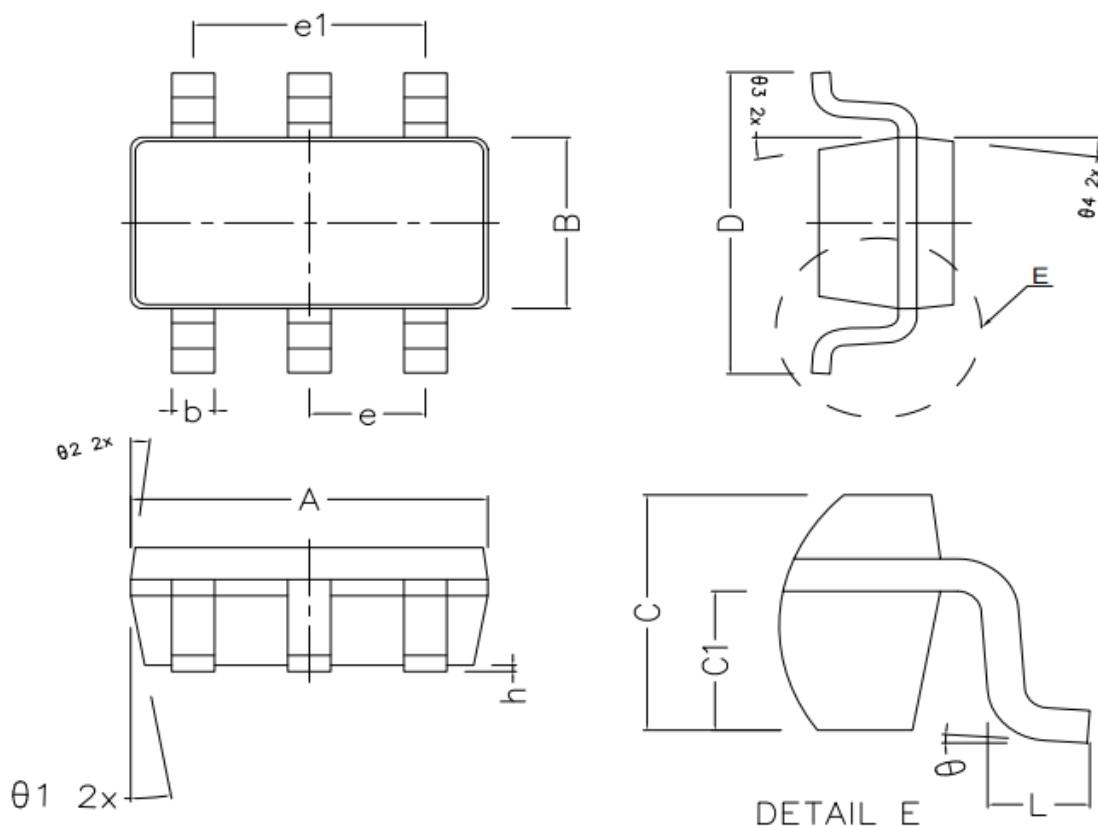


Figure 10: Square Wave Pulse Duration (sec) vs Normalized Effective Transient Thermal Impedance

**20V/7A Dual N-Channel Enhancement Mode MOSFET**
**Test Circuit and Waveform:**

**Figure A Gate Charge Test Circuit & Waveforms**

**Figure B Switching Test Circuit & Waveforms**

**Figure C Unclamped Inductive Switching Circuit & Waveforms**

**20V/7A Dual N-Channel Enhancement Mode MOSFET**
**SOT-23-6L Package Outline Dimensions (Units: mm)**


COMMON DIMENSIONS (UNITS OF MEASURE IS mm)			
	MIN	NORMAL	MAX
A	2.820	2.920	3.020
B	1.500	1.600	1.700
C	1.050	1.100	1.150
C1	0.600	0.650	0.700
D	2.650	2.800	2.950
L	0.300	0.450	0.600
b	0.280	0.350	0.420
h	0.020	0.050	0.100
K	0.120	—	0.230
e	0.950TYPE		
e1	1.900TYPE		
θ <sub>1</sub>	10° TYPE		
θ <sub>2</sub>	7° TYPE		
θ <sub>3</sub>	10° TYPE		
θ <sub>4</sub>	7° TYPE		
θ	0° ~ 8°		